6	OptoSupply
	Light It Up

	PCB Heat Sink for Xeon Power LED							
Item	Part Number	Description	Dimension	Photo	Application			
1W	OSMCPCB8060B	<ul> <li>Aluminum metal-base copper-clad laminate PCB</li> <li>Design for Xeon 1 Power Series LED</li> <li>Base metal is 1.5mm Aluminum</li> <li>With NTCD Thermally Conductive Dielectric</li> <li>Copper Circuit Foil is 35 μ m(1oz)</li> <li>Surface Finish is Black Solder Mask, Pb-free HASL solder pads (RoHS compliant)</li> </ul>	19.9 19.9		Suitable for Xeon Power 1W LED (OSXXXNE1E1E):			
3W	OSMCPCB8060A	<ul> <li>Aluminum metal-base copper-clad laminate PCB</li> <li>Design for Xeon 3 Power Series LED</li> <li>Base metal is 1.5mm Aluminum</li> <li>With HTCD Thermally Conductive Dielectric to suitable high power LED</li> <li>Copper Circuit Foil is 35 µ m(1oz)</li> <li>Surface Finish is White Solder Mask, Pb-free HASL solder pads (RoHS compliant)</li> </ul>	19.9 19.9 19.9 19.9 19.9 10.0		Suitable for Xeon Power 3W LED (OSXXXNE3E1E)			



## **Appendix**

## Data and information for MCPCB

Items	Unit	<u>Reference</u>
Thermal Conductivity	W/mK	0.8W/mK
Dielectric thickness	$\mu$ m	100
Breakdown voltage	kV(DC)	> 3kV
Insulation resistance	Ω	10 <sup>5</sup>
Maximum Working Temperature	°C	130
Peel Strength	N/mm	> 1.4
Blistering after heat shock within 1 minutes	°C	<260
Copper thickness	$\mu$ m	35
Base metal plate	-	Aluminum
Base metal thickness	mm	1.5